## **Vishay Semiconductors**

**HFA80FA120P** 

## **HEXFRED**<sup>®</sup> Ultrafast Soft Recovery Diode, 80 A

#### **FEATURES**

- Fast recovery time characteristic
- · Electrically isolated base plate
- Large creepage distance between terminal
- · Simplified mechanical designs, rapid assembly
- UL approved file E78996
- Compliant to RoHS directive 2002/95/EC
- Designed and qualified for industrial level

#### **DESCRIPTION/APPLICATIONS**

The dual diode series configuration (HFA80FA120P) is used for output rectification or freewheeling/clamping operation and high voltage application.

The semiconductor in the SOT-227 package is isolated from the copper base plate, allowing for common heatsinks and compact assemblies to be built.

These modules are intended for general applications such as HV power supplies, electronic welders, motor control and inverters.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Cathode to anode voltage	V <sub>R</sub>		1200	V	
Continuous forward current	١ <sub>F</sub>	T <sub>C</sub> = 78 °C	40		
Single pulse forward current	I <sub>FSM</sub>	T <sub>J</sub> = 25 °C	400	А	
Maximum repetitive forward current	I <sub>FRM</sub>	Rated $V_{R_i}$ square wave, 20 kHz, $T_C$ = 60 °C	72		
Maximum newer dissinction	р	T <sub>C</sub> = 25 °C	178	W	
Maximum power dissipation	P <sub>D</sub>	T <sub>C</sub> = 100 °C	71	vv	
RMS isolation voltage	V <sub>ISOL</sub>	Any terminal to case, t = 1 min	2500	V	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		- 55 to + 150	°C	

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V <sub>BR</sub>	I <sub>R</sub> = 100 μA		1200	-	-	
Forward voltage V <sub>FM</sub>		I <sub>F</sub> = 25 A	See fig. 1	-	2.6	3.0	V
	V <sub>FM</sub>	I <sub>F</sub> = 40 A		-	2.9	3.3	
	I <sub>F</sub> = 80 A, T <sub>J</sub> = 125 °C		-	3.4	-		
Deverse legiser summert		V <sub>R</sub> = V <sub>R</sub> rated	See fig. 0	-	2.0	-	μA
Reverse leakage current	$T_J$ = 125 °C, $V_R$ = 0.8 x $V_R$ rated	See fig. 2	-	0.5	2	mA	
Junction capacitance	CT	V <sub>R</sub> = 200 V	See fig. 3	-	43	-	pF

PRODUCT SUMMARY	
V <sub>R</sub>	1200 V
V <sub>F</sub> (typical)	2.6 V
t <sub>rr</sub> (typical)	25 ns
I <sub>F(DC)</sub> at T <sub>C</sub>	40 A at 78 °C







# HFA80FA120P

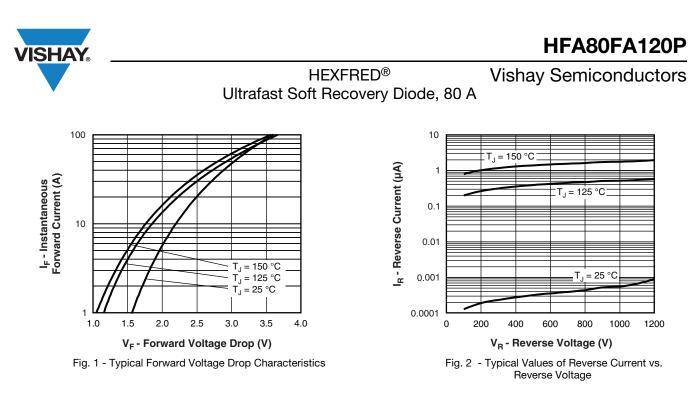


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### HEXFRED<sup>®</sup> Ultrafast Soft Recovery Diode, 80 A

<b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_C = 25 \text{ °C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
		$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}, \text{ V}_R = 30 \text{ V}$		-	25	-	
Reverse recovery time	erse recovery time t <sub>rr</sub>	T <sub>J</sub> = 25 °C	I <sub>F</sub> = 40 A dI <sub>F</sub> /dt = - 200 A/μs V <sub>R</sub> = 200 V	-	52	-	ns - A
		T <sub>J</sub> = 125 °C		-	110	-	
Peak recovery current I <sub>RRM</sub>		T <sub>J</sub> = 25 °C		-	5.9	-	
	IRRM	T <sub>J</sub> = 125 °C		-	10.8	-	
Reverse recovery charge Q <sub>rr</sub>	0	T <sub>J</sub> = 25 °C		-	160	-	nC
	Q <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	630	-	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Junction to case, single leg conducting	Р		-	-	0.7	
Junction to case, both legs conducting	– R <sub>thJC</sub>		-	-	0.35	°C/W
Case to heatsink	R <sub>thCS</sub>	Flat, greased and surface	-	0.05	-	
Weight			-	30	-	g
Mounting torque			-	1.3	-	Nm



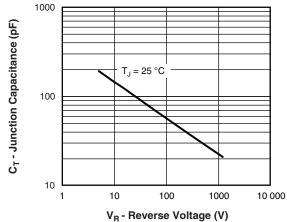


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

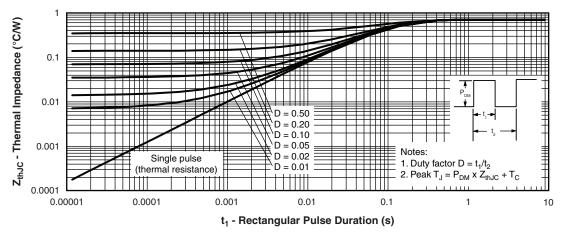


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics

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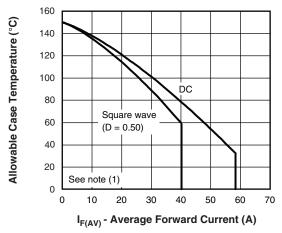
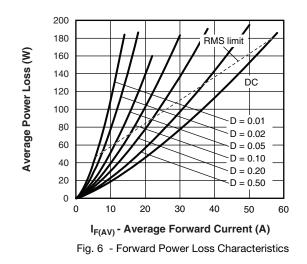


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current



#### Note

- <sup>(1)</sup> Formula used:  $T_C = T_J (Pd + Pd_{REV}) \times R_{thJC};$ Pd = Forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see fig. 6);  $Pd_{REV}$  = Inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_{R1}$  = Rated  $V_R$

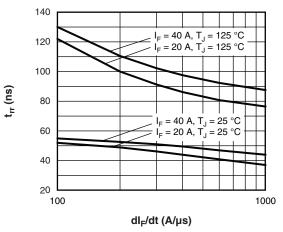


Fig. 7 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

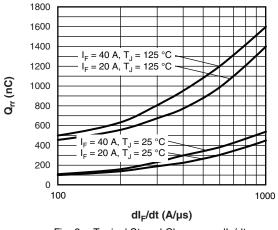


Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt



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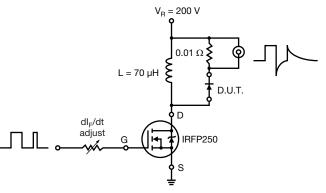


Fig. 9 - Reverse Recovery Parameter Test Circuit

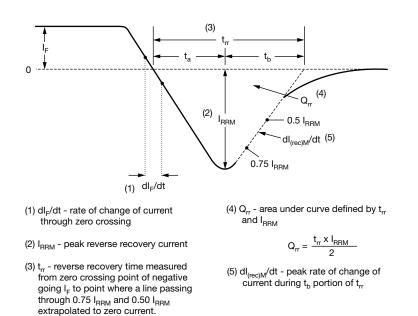


Fig. 10 - Reverse Recovery Waveform and Definitions

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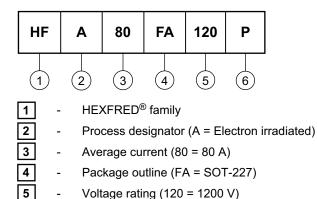
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#### **ORDERING INFORMATION TABLE**

Device code

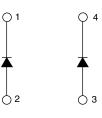


Average current (80 = 80 A)

- Package outline (FA = SOT-227)
- Voltage rating (120 = 1200 V)
- P = Lead (Pb)-free

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#### **CIRCUIT CONFIGURATION**



LINKS TO RELATED DOCUMENTS				
Dimensions www.vishay.com/doc?95036				
Packaging information <u>www.vishay.com/doc?95037</u>				



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